Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

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GeneSiC SEMICONDUCTOR

2N7636-GA

Normally – OFF Silicon Carbide Super Junction Transistor

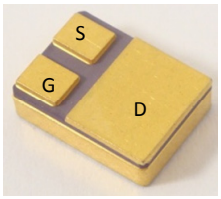
V_{DS}	=	650 V
$V_{DS(ON)}$	=	1.7 V
I_D	=	4 A
$R_{DS(ON)}$	=	415 mΩ

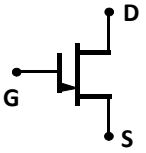
Features

- 250 °C maximum operating temperature
- Temperature independent switching performance
- Gate oxide free SiC switch
- Suitable for connecting an anti-parallel diode
- Positive temperature coefficient for easy paralleling
- Low gate charge
- Low intrinsic capacitance

Package

- RoHS Compliant





SMD0.5 / TO – 276 (Hermetic Package)

Advantages

- Low switching losses
- Higher efficiency
- High temperature operation
- High short circuit withstand capability

Applications

- Down Hole Oil Drilling, Geothermal Instrumentation
- Hybrid Electric Vehicles (HEV)
- Solar Inverters
- Switched-Mode Power Supply (SMPS)
- Power Factor Correction (PFC)
- Induction Heating
- Uninterruptible Power Supply (UPS)
- Motor Drives

Maximum Ratings at T_j = 250 °C, unless otherwise specified

Parameter	Symbol	Conditions	Values	Unit
Drain – Source Voltage	V_{DS}	V_{GS} = 0 V	650	V
Continuous Drain Current	I_D	T_C = 165 °C	4	A
Gate Peak Current	I_{GM}		5	A
Reverse Gate – Source Voltage	V_{GS}		200	V
Reverse Drain – Source Voltage	V_{DS}		40	V
Power Dissipation	P_{tot}	T_C = 25 °C	7	W
Operating and Storage Temperature	T_j, T_{stg}		-55 to 250	°C

Electrical Characteristics at T_j = 250 °C, unless otherwise specified

Parameter	Symbol	Conditions	Values min.	Values typ.	Values max.	Unit
On Characteristics						
Drain – Source On Voltage	$V_{DS(ON)}$	I_D = 4 A, I_G = 100 mA, T_j = 25 °C		1.7		V
		I_D = 4 A, I_G = 250 mA, T_j = 175 °C		3.2		
		I_D = 4 A, I_G = 250 mA, T_j = 250 °C		4.7		
Drain – Source On Resistance	$R_{DS(ON)}$	I_D = 4 A, I_G = 100 mA, T_j = 25 °C		415		mΩ
		I_D = 4 A, I_G = 250 mA, T_j = 175 °C		820		
		I_D = 4 A, I_G = 250 mA, T_j = 250 °C		1310		
Gate Forward Voltage	$V_{GS(FWD)}$	I_G = 500 mA, T_j = 25 °C		3.3		V
		I_G = 500 mA, T_j = 250 °C		3.2		
DC Current Gain	β	V_{DS} = 5 V, I_D = 5 A, T_j = 25 °C		120		
		V_{DS} = 5 V, I_D = 5 A, T_j = 250 °C		85		
Off Characteristics						
Drain Leakage Current	I_{DSS}	V_R = 650 V, V_{GS} = 0 V, T_j = 25 °C		7		nA
		V_R = 650 V, V_{GS} = 0 V, T_j = 175 °C		25		
		V_R = 650 V, V_{GS} = 0 V, T_j = 250 °C		105		

Electrical Characteristics at T_j = 250 °C, unless otherwise specified

Parameter	Symbol	Conditions	Values min.	Values typ.	Values max.	Unit
Dynamic Characteristics						
Input Capacitance	C_{iss}	V_{DS} = 35 V, V_{GS} = 0 V, f = 1 MHz, T_{vj} = 25 °C		324		pF
Output Capacitance	C_{oss}			45		pF
Reverse Transfer Capacitance	C_{rss}			45		pF
Switching Characteristics						
Turn On Delay Time	$t_{d(on)}$	V_{DD} = 400 V, I_D = 5 A, $R_{G(on)}$ = $R_{G(off)}$ = 44 Ω, V_{GS} = -8/15 V ,T_j = 175 ºC Refer to Figure 10 for gate drive current waveforms		5		ns
Rise Time	t_r			15		ns
Turn Off Delay Time	$t_{d(off)}$			74		ns
Fall Time	t_f			14		ns
Turn-On Energy Per Pulse	E_{on}			24		µJ
Turn-Off Energy Per Pulse	E_{off}			7		µJ
Total Switching Energy	E_{ts}			31		µJ
Turn On Delay Time	$t_{d(on)}$	V_{DD} = 400 V, I_D = 5 A, $R_{G(on)}$ = $R_{G(off)}$ = 44 Ω, V_{GS} = -8/15 V ,T_j = 250 ºC Refer to Figure 10 for gate drive current waveforms		9		ns
Rise Time	t_r			24		ns
Turn Off Delay Time	$t_{d(off)}$			114		ns
Fall Time	t_f			17		ns
Turn-On Energy Per Pulse	E_{on}			54		µJ
Turn-Off Energy Per Pulse	E_{off}			10		µJ
Total Switching Energy	E_{ts}			64		µJ
Thermal Characteristics						
Thermal resistance, junction - case	R_{thJC}			1.6		°C/W

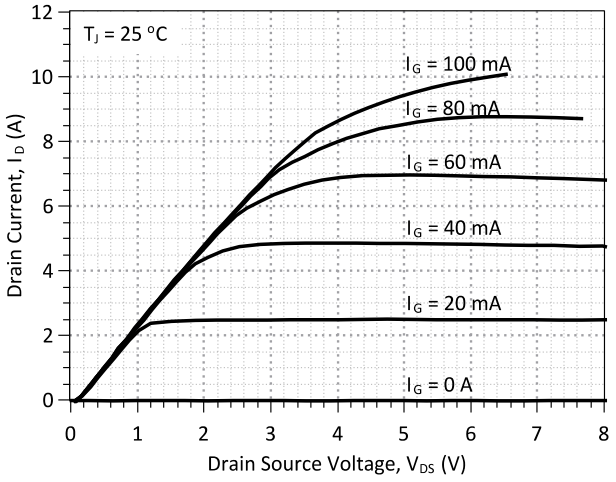


Figure 1: Typical Output Characteristics at 25 °C

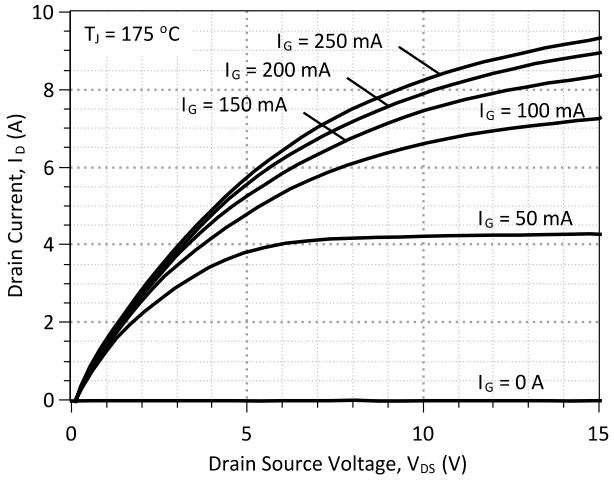


Figure 2: Typical Output Characteristics at 175 °C

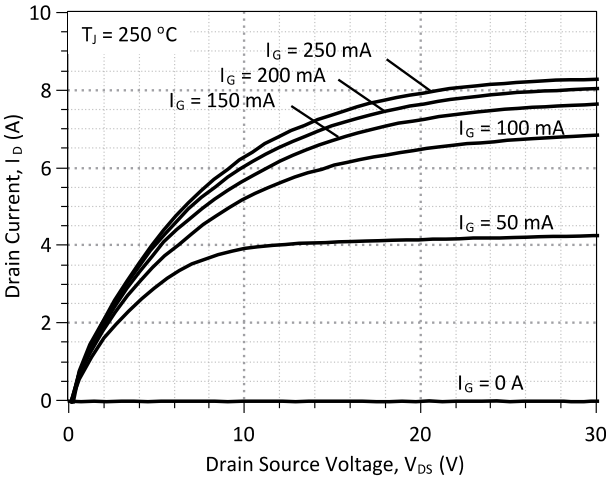


Figure 3: Typical Output Characteristics at 250 °C

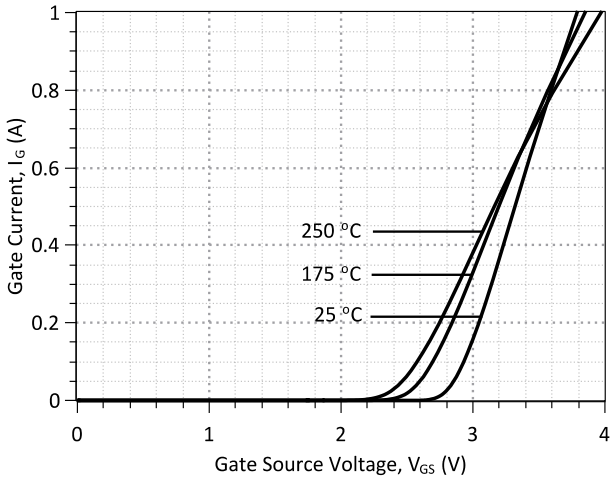


Figure 4: Typical Gate Source I-V Characteristics vs. Temperature

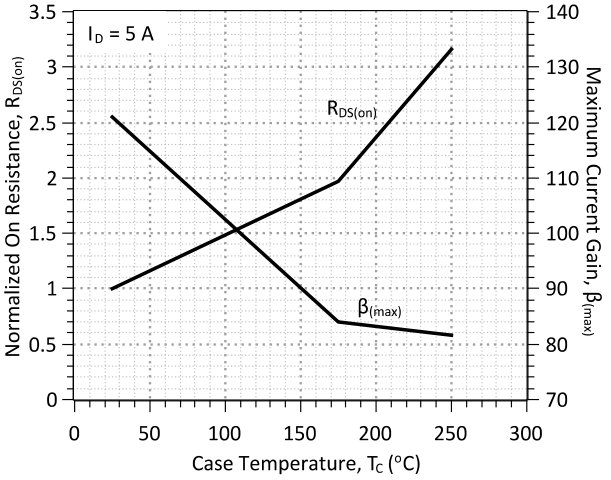


Figure 5: Normalized On-Resistance and Current Gain vs. Temperature

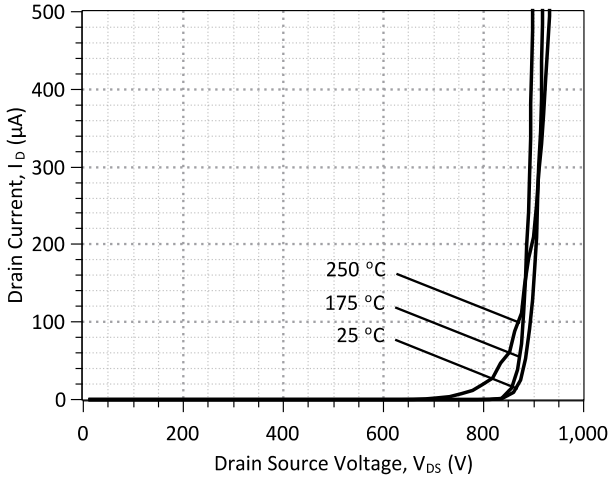


Figure 6: Typical Blocking Characteristics

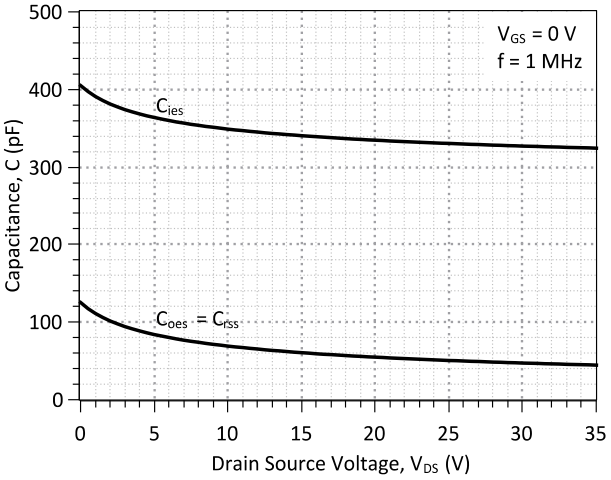


Figure 7: Typical Capacitance vs Drain-Source Voltage

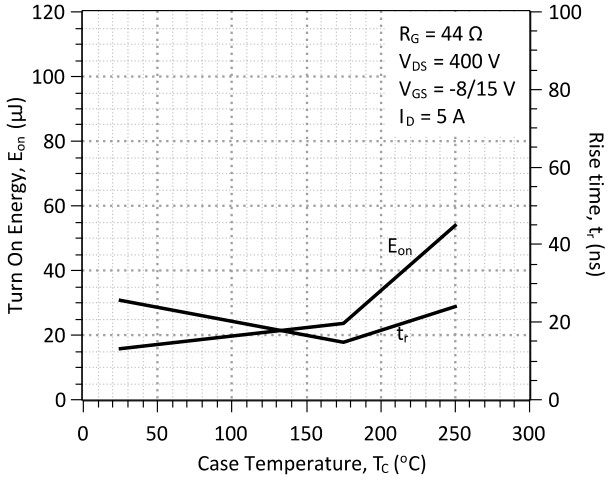


Figure 8: Typical Turn On Energy Losses and Switching Times vs. Temperature

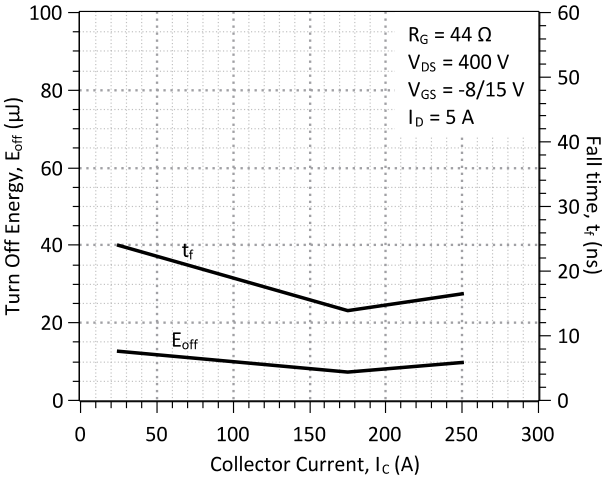


Figure 9: Typical Turn Off Energy Losses and Switching Times vs. Temperature

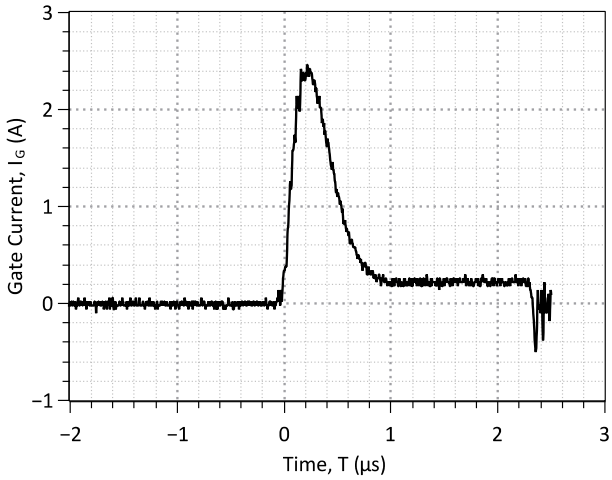
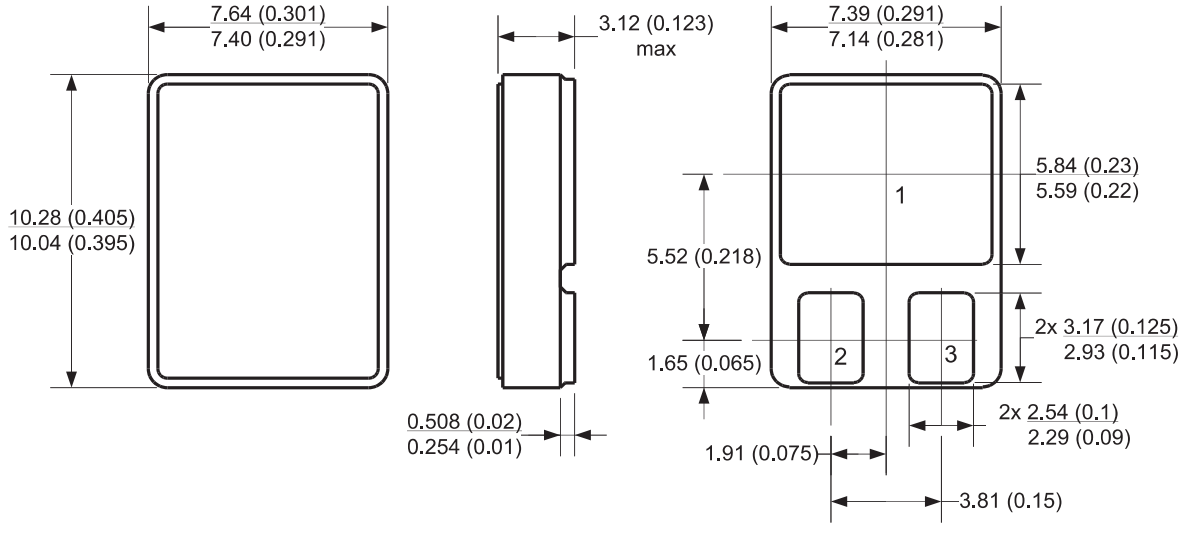


Figure 10: Typical Gate-Source Switching Waveforms

Package Dimensions:

SMD-0.5/TO-276 **PACKAGE OUTLINE**



NOTE
1. CONTROLLED DIMENSION IS INCH. DIMENSION IN BRACKET IS MILLIMETER.
2. DIMENSIONS DO NOT INCLUDE END FLASH, MOLD FLASH, MATERIAL PROTRUSIONS

Revision History			
Date	Revision	Comments	Supersedes
2012/08/24	0	Initial release	

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